	Hits	Search Text	DBs
1	301	photo\$4acid) near7 (generat\$4 or liberat\$4)) or PAG or (acid near8	
2	120	pnoto\$4acid) near/ (generat\$4 or liberat\$4)) or PAG or (acid near8	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB

	Hits	Search Text	DBs
3	1	(generat\$4), or PAG or (acid hears (generat\$4 or liberat\$4))) same	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
4	182	430/270.1.ccls. and ((metal\$4 or film or dielectric or ((under or bottom) near8 (layer or film or coat\$3))) same (photoresist or resist or photo\$4cur\$4 or photo\$3imageable) same (novolac or epoxy or resin) same (((photoactive or photo\$4acid) near7 (generat\$4 or liberat\$4)) or PAG or (acid near8 (generat\$4))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB

	Hits	Search Text	DBs
5	2	mear/ (generats4 or liberats4))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
6	128	((under or bottom or conductive or metal\$4 or dielectric) near14 (deposit\$4 or form\$3 or layer or film or coat\$3)) and ((photoresist or resist or photo\$4cur\$4 or photo\$3imageable) same (novolac or epoxy or resin\$3) same ((photoactive or photo\$4acid) near7 (generat\$4 or liberat\$4)) same (generat\$4 or liberat\$4)) same	IBM_TDB

	Hits	Search Text	DBs
7	0	(expos\$4 or illuminat\$4 or	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB

	Hits	Search Text	DBs
8	0	(exposs4 or illuminats4 or irradiats4) and	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB

	Hits	Search Text	DBs
9	3	(expos\$4 or illuminat\$4 or irradiat\$4) same pattern\$4) and develop\$4 and ((solubilization or	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB

	Hits	Search Text	DBs
10	0	(expos\$4 or illuminat\$4 or	US-PGPUB; USPAT; EPO; JPO; DERWENT;

	Hits	Search Text	DBs
11	8	phenss; same (((photoactive or photos4acid) near? (generats4 or	TRW_LDB
12	194	(((under or bottom or conductive or metal\$4 or dielectric) near14 (deposit\$4 or form\$3 or layer or film or coat\$3)) same pattern\$4) and ((photoresist or resist or photo\$4cur\$4 or photo\$3imageable) same (novolac or epoxy or resin\$3) same (((photoactive or photo\$4acid) near7 (generat\$4 or liberat\$4))) same (generat\$4 or liberat\$4)) same	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB

	Hits	Search Text	DBs
13	24	(((under or bottom or conductive or metal\$4 or dielectric) near14 (deposit\$4 or form\$3 or layer or film or coat\$3)) same pattern\$4) and ((photoresist or resist or photo\$4cur\$4 or photo\$3imageable) same (novolac or epoxy or resin\$3) same (((photoactive or photo\$4acid) near7 (generat\$4 or liberat\$4)) or PAG or (acid near8 (generat\$4 or liberat\$4))) same (expos\$4 or illuminat\$4 or irradiat\$4) same pattern\$4) and develop\$4 and ((solubilization or \$3solubilizing or soluble or solubility or insoluble) same (prevent\$4 or caus\$4 or inhibit\$4)) and (etch\$4 or RIE or (dry near5 etch\$4)) and (vinyl near9 phenol) and \$4hydroxy\$3styrene	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
14	11	(((under or bottom or conductive or metal\$4 or dielectric) near14 (deposit\$4 or form\$3 or layer or film or coat\$3)) same pattern\$4) and ((photoresist or resist or photo\$4cur\$4 or photo\$3imageable) same (((photoactive or photo\$4acid) near7 (generat\$4 or liberat\$4)) or PAG or (acid near8)	USPAT; EPO; JPO; DERWENT; IBM_TDB

	Hits	Search Text	DBs
15	23	same (expos\$4 or illuminat\$4 or	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
16	0	(((under or bottom or conductive or metal\$4 or dielectric) near14 (deposit\$4 or form\$3 or layer or film or coat\$3)) same pattern\$4 same (substrate or wafer or device) same (pedestal or stage or hold\$3)) and ((photoresist or resist or photo\$4cur\$4 or photo\$3imageable) same (expos\$4 or illuminat\$4 or irradiat\$4)	

,	Hits	Search Text	DBs
17	0	(((under or bottom or conductive or metal\$4 or dielectric) near14 (deposit\$4 or form\$3 or layer or film or coat\$3)) same pattern\$4 same (substrate or wafer or device) same (pedestal or stage or hold\$3)) and ((photoresist or resist or photo\$4cur\$4 or photo\$3imageable) same (expos\$4 or illuminat\$4 or irradiat\$4) same pattern\$4) and develop\$4 and (etch\$4 or RIE or (dry near5 etch\$4)) and (CD or (critical near5 dimension)) and (LER or LWR or (line near4 (wid\$2 or edge) near4 rough\$5))	USPAT; EPO; JPO; DERWENT; IBM_TDB
18	2	(((under or bottom or conductive or metal\$4 or dielectric) near14 (deposit\$4 or form\$3 or layer or film or coat\$3)) same pattern\$4) and ((photoresist or resist or photo\$4cur\$4 or photo\$3imageable) same (substrate or wafer or device) same (pedestal or stage or hold\$3) same (expos\$4 or	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB

	Hits	Search Text	DBs
19		((under or bottom or conductive or metal\$4 or dielectric) near14 (deposit\$4 or form\$3 or layer or film or coat\$3)) and ((photoresist or resist or photo\$4cur\$4 or photo\$3imageable) same (expos\$4 or illuminat\$4 or irradiat\$4) same pattern\$4) and develop\$4 and (etch\$4 or RIE or (dry near5 etch\$4)) and ((CD or (critical near5 dimension)) same (nm or nanometer)) and ((LER or LWR or (line near4 (wid\$2 or edge) near4 rough\$5)) same (nm or nanometer))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
20	19	(((under or bottom or conductive or metal\$4 or dielectric) near14 (deposit\$4 or form\$3 or layer or film or coat\$3)) same pattern\$4) and ((photoresist or resist or photo\$4cur\$4 or photo\$3imageable) same (novolac or epoxy or resin\$3) same vinyl same ((photoactive or photo\$4acid)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB

	Hits	Search Text	DBs
21	36	same (expos\$4 or illuminat\$4 or	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
22	15	((bottom or conductive or metal\$4 or dielectric or circuit\$4) near14 (deposit\$4 or form\$3 or layer or film or coat\$3)) and (photolithograph\$6) and develop\$4 and ((CD or (critical near5	US-PGPUB;